



Product Summary

BV _{DSS}	R _{DS(ON)} Max	Ι _D T _A = +25°C		
201/	$23m\Omega @ V_{GS} = 10V$	6.6A		
30V	$30m\Omega @ V_{GS} = 4.5V$	5.8A		

Description

This new generation MOSFET is designed to minimize the on-state resistance ($R_{DS(ON)}$), yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

Applications

- DC-DC Converters
- Power management functions
- Backlighting

30V N-CHANNEL ENHANCEMENT MODE MOSFET

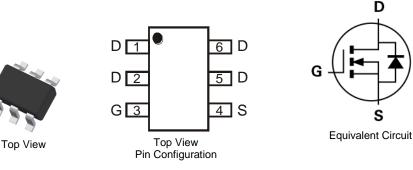
Features and Benefits

- Low Input Capacitance
- Low On-Resistance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

Mechanical Data

- Case: TSOT26
- Case Material: Molded Plastic, "Green" Molding Compound; UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Tin Finish Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (c3)
- Weight: 0.013 grams (Approximate)

TSOT26



Ordering Information (Note 5)

Part Number	Case	Packaging
DMN3026LVTQ-7	TSOT26	3,000/Tape & Reel
DMN3026LVTQ-13	TSOT26	10,000/Tape & Reel

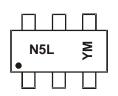
Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified. For more information, please refer to http://www.diodes.com/quality/product_compliance_definitions/.

5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.



N5L = Product Type Marking Code YM = Date Code Marking Y = Year (ex: A = 2013) M = Month (ex: 9 = September)

Date Code Key												
Year	2010		2014	201	5 20 ⁻	16 2	2017	2018	2019	2020	2021	2022
Code	Х		В	С	D		E	F	G	Н		J
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	Ν	D

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units		
Drain-Source Voltage	V _{DSS}	30	V		
Gate-Source Voltage	V _{GSS}	±20	V		
Continuous Drain Current (Note 7) \/ 10\/	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	ID	6.6 5.3	А
Continuous Drain Current (Note 7) V _{GS} = 10V	t<10s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	Ι _D	8.5 6.8	А
Maximum Body Diode Forward Current (Note 7)	Is	3.0	А		
Pulsed Drain Current (10µs pulse, duty cycle = 1%)	I _{DM}	35	А		

Thermal Characteristics

Characteristic	Symbol	Value	Units	
Total Power Dissipation (Note 6)	$T_A = +25^{\circ}C$	Р	1.2	W
	T _A = +70°C	PD	0.8	vv
Thermal Resistance, Junction to Ambient (Note 6)	Steady state	Devi	100	°C/W
Thermal Resistance, surction to Ambient (Note 6)	t<10s	R _{θJA}	60	°C/W
Total Power Dissipation (Note 7)	T _A = +25°C	Р	1.5	W
	T _A = +70°C	PD	1.0	
Thermal Resistance, Junction to Ambient (Note 7)	Steady state	Devi	83	°C/W
Thermal Resistance, surction to Ambient (Note 7)	t<10s	R _{θJA}	50	°C/W
Thermal Resistance, Junction to Case (Note 7)		R _{θJC}	14.5	°C/W
Operating and Storage Temperature Range		T _{J,} T _{STG}	-55 to +150	°C



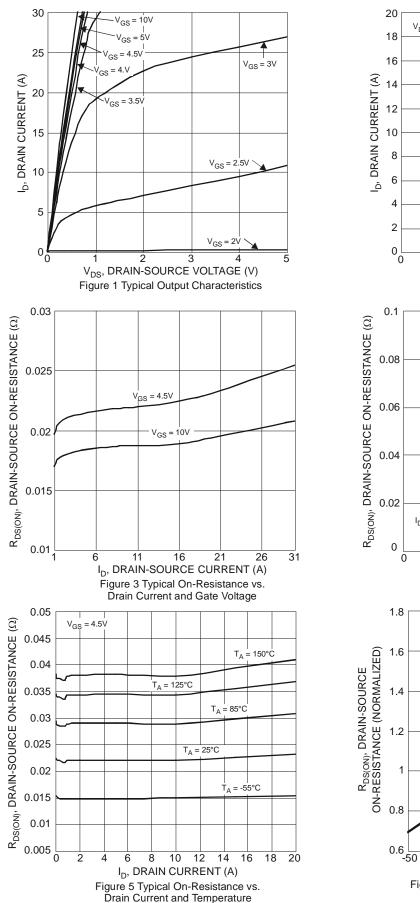
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

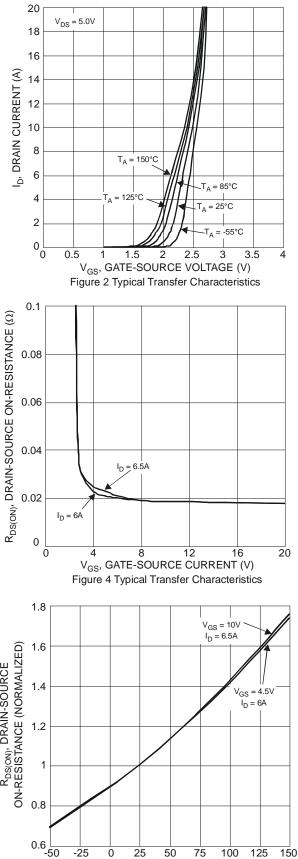
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BV _{DSS}	30	_	_	V	$V_{GS} = 0V, I_D = 250 \mu A$	
Zero Gate Voltage Drain Current	IDSS	_	_	1.0	μA	$V_{DS} = 30V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	_	—	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	V _{GS(th)}	1.0	1.5	2.0	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$	
Static Drain-Source On-Resistance	Proven	_	19	23	mΩ	$V_{GS} = 10V, I_D = 6.5A$	
	R _{DS(ON)}	—	22	30	11152	$V_{GS} = 4.5 V, I_D = 6.0 A$	
Diode Forward Voltage	V _{SD}	_	0.7	1.2	V	$V_{GS} = 0V, I_{S} = 1.0A$	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	Ciss	—	643	_		V _{DS} = 15V, V _{GS} = 0V f = 1.0MHz	
Output Capacitance	Coss	—	65	_	pF		
Reverse Transfer Capacitance	Crss	—	49	_			
Gate Resistance	R _G	—	2.5	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Qg	—	5.7	_			
Total Gate Charge (V _{GS} = 10V)	Qg	—	12.5	_	nC	$V_{DS} = 15V, I_D = 4.0A$	
Gate-Source Charge	Q _{gs}	—	1.7	_			
Gate-Drain Charge	Q _{gd}	—	1.8	_			
Turn-On Delay Time	t _{D(on)}	_	2.2	—			
Turn-On Rise Time	tr		2.5	_	nS	$V_{GS} = 10V, V_{DD} = 15V, R_G = 6.0\Omega,$	
Turn-Off Delay Time	t _{D(off)}		12.1	—	15	I _D = 6.5A	
Turn-Off Fall Time	t _f		3.0	_	1		
Body Diode Reverse Recovery Time	t _{rr}	—	6.5	_	nS	I _F = 6.5A, dl/dt = 100A/µs	
Body Diode Reverse Recovery Charge	Q _{rr}		1.7	_	nC	I _F = 6.5A, dI/dt = 100A/µs	

 Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
Device mounted on FR-4 substrate PC board, 2oz copper, with 1-inch square copper plate.
Short duration pulse test used to minimize self-heating effect.
Guaranteed by design. Not subject to product testing. Notes:









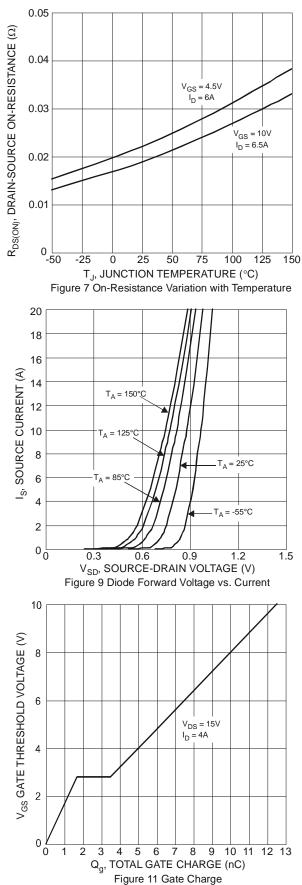
T_J, JUNCTION TEMPERATURE (°C)

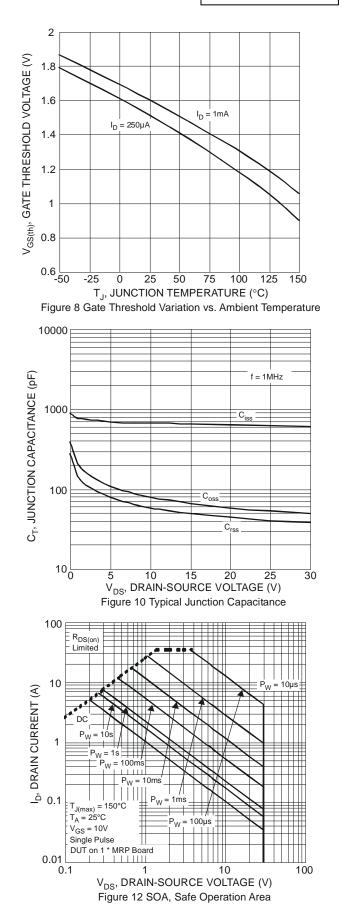
Figure 6 On-Resistance Variation with Temperature

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DMN3026LVTQ

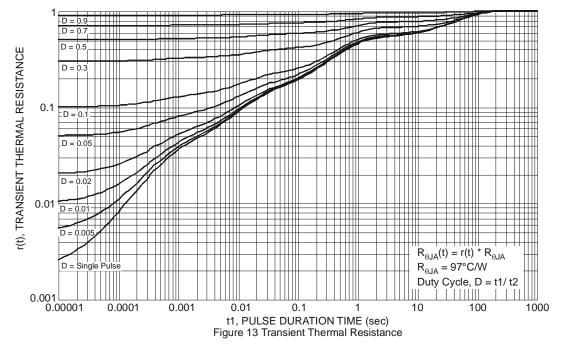






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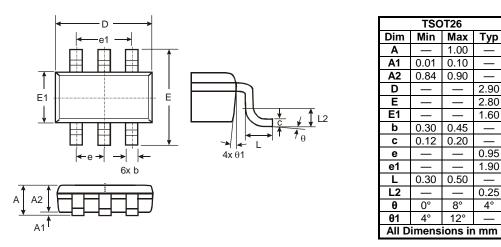




Package Outline Dimensions

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

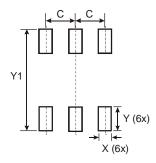
TSOT26



Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.

TSOT26



Dimensions	Value (in mm)
С	0.950
Х	0.700
Y	1.000
Y1	3.199

Max

1.00

0.10

0.90

0.45

0.20

8°

12°

Тур

2.90

2.80

1.60

0.95

1.90

0.25

4°



DMN3026LVTQ

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